

SMALL SIGNAL SWITCHING DIODE

FEATURES

- . Silicon epitaxial planar diode
- . Fast swithching diodes
- . 500mW power dissipation
- . The diode is also available in the DO-35 case with the type designation 1N4148

0.063 (1.6) 0.055 (1.4) 0.142 (3.6) 0.134 (3.4)

Dimensions in inches and (millimeters)

MECHANICAL DATA

. Case: MinMelf glass case(SOD- 80)

. Weight: Approx. 0.05gram

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(Ratings at 25°C ambient temperature unless otherwise specified)

Symbol	Value	Units
VR	75	Volts
VRM	100	Volts
lav	1501)	mA
IFSM	500	mA
Ptot	5001)	mW
TJ	175	$^{\circ}$
T _{STG}	-65 to + 175	$^{\circ}$
	VR VRM IAV IFSM Ptot TJ	VR 75 VRM 100 IAV 1501) IFSM 500 Ptot 5001) TJ 175

ELECTRICAL CHARACTERISTICS

(Ratings at 25°C ambient temperature unless otherwise specified)

	Symbols	Min.	Тур.	Max.	Units
Forward voltage	VF			1	Volts
Leakage current at VR=20V	lr			25	nA
at V _R =75V	lr			5	nA
at VR=20V, TJ=150°C	lr			50	nA
Junction capacitance at VR=VF=0V	Сл			4	pF
Voltage rise when switching ON tested with 50mA	Vfr			2.5	Volts
pulse Tp=0.1 μ S, Rise time<30 μ S, fp=5 to 100KHz	VII				
Reverse recovery time from IF=10mA to IR=1mA,	trr			4	ns
VR=6V, RL=100 Ω					
Thermal resistance junction to ambient	Rθ JA			3501)	K/W
Rectification efficience at f=100MHz,VRF=2V	η	0.45			
1)Valid provided that leads at a distance of 8mm from case	e are kent at amhien	t temperature(DO-35)	_	_

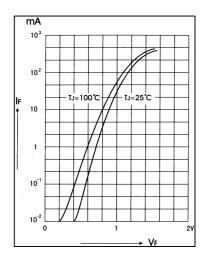




RATINGS AND CHATACTERISTIC CURVES LL4148

FLG.1-FORWARD CHARACTERISTICS

FIG.2-DYNAMIC FORWARD RESISTANCE VERSUS FORWARD CURRENT



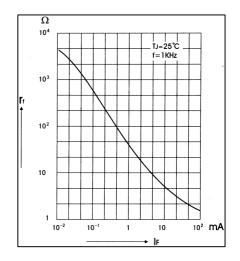
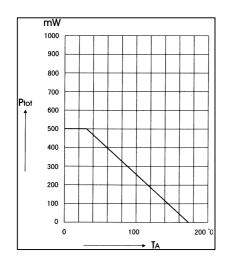
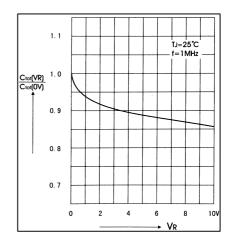


FIG.3-ADMISSIBLE POWER DISSIPATION VERSUS AMBIENT TEMPERATURE

FIG.4-RELATIVE CAPACITANCE VERSUS VOLTAGE







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FIG.5-RECTIFICATION EFFICIENCY MEASUREMENT CIRCUIT

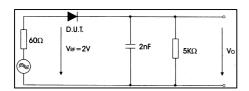


FIG.6-LEAKAGE CURRENT VERSUS JUNCTION TEMPERATURE

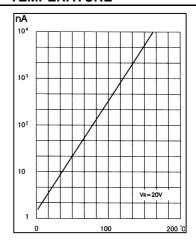


FIG.7-ADMISSIBLE REPETITIVE PEAK FORWARD CURRENT VERSUS PULSE DURATION

